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# ML9472

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Static,1/2Duty 60 Output LCD Driver

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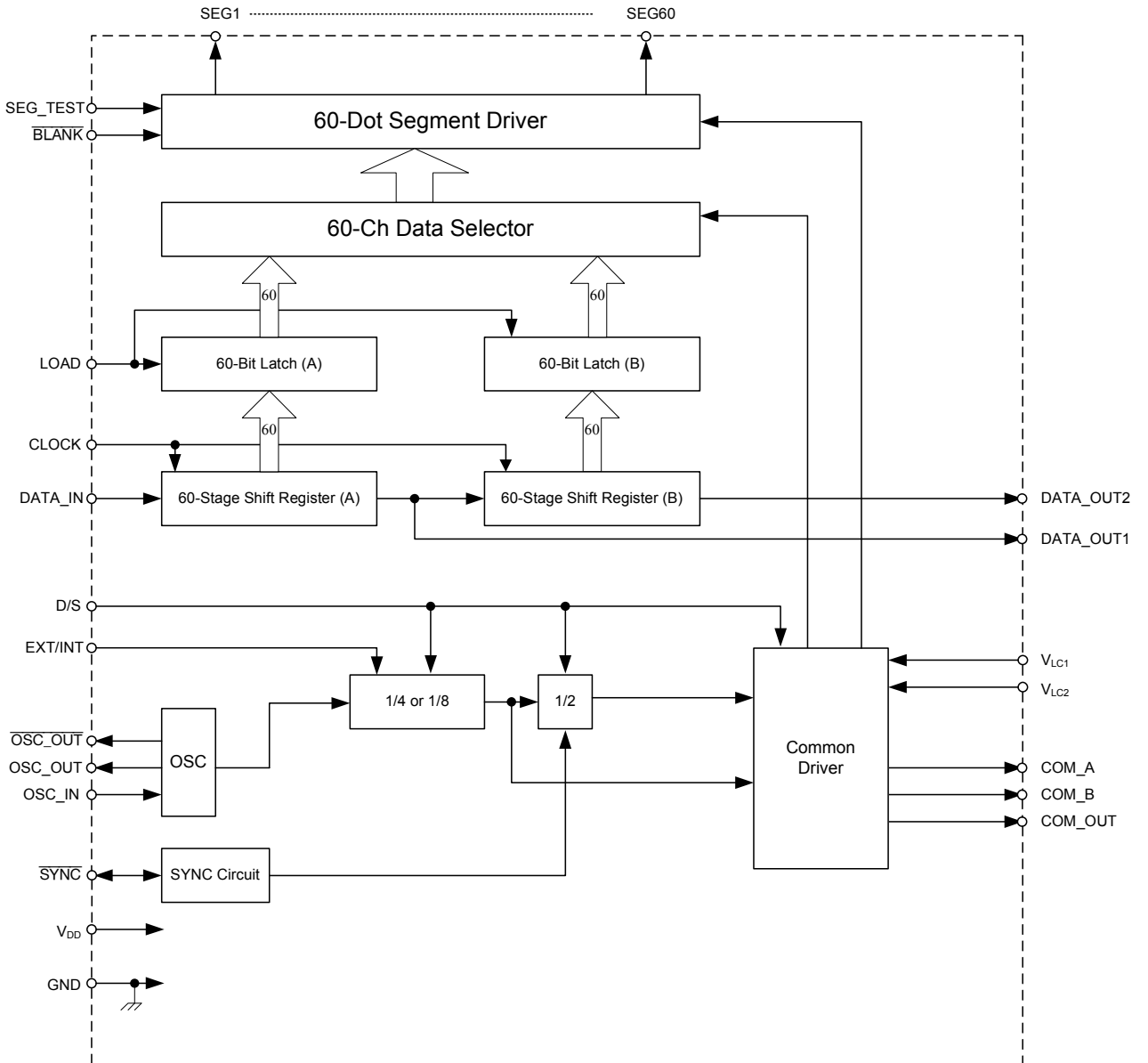
## GENERAL DESCRIPTION

The ML9472 is a LCD driver which can directly drive up to 60 segments in the static display mode and up to 120 segments in the 1/2 duty dynamic display mode.

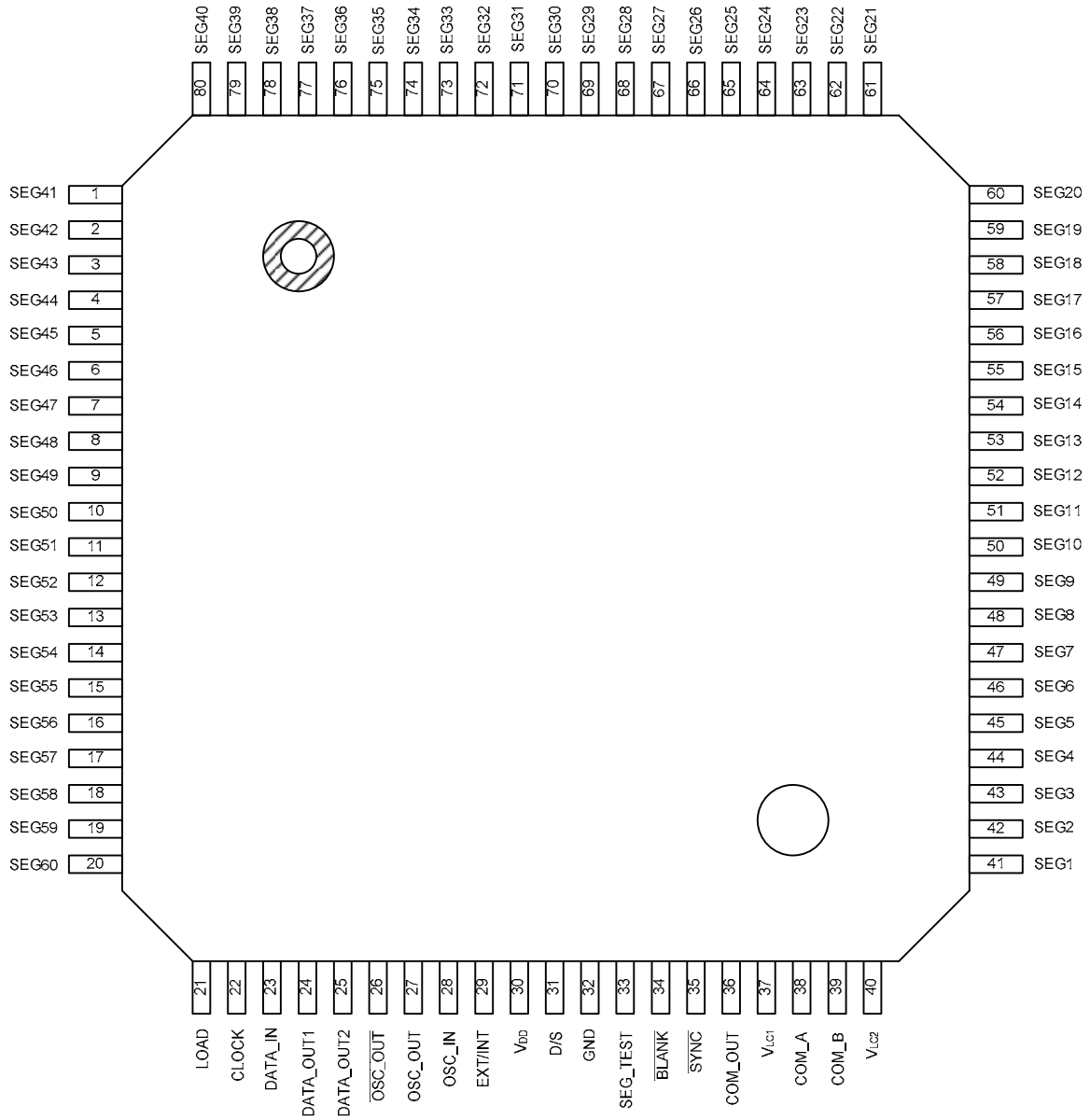
## FEATURES

- Operating range
  - Supply voltage : 3.0 to 5.5 V
  - Operating temperature range : -40 to + 105°C
- Segment output
  - Static display mode : Up to 60 segments can be displayed.
  - 1/2 duty : Up to 120 segments can be displayed.
- Simple interface with microcomputer
- Built-in common signal generator
- One-to-one correspondence between input data and output data
  - When input data is at "H" level : Display goes on.
  - When input data is at "L" level : Display goes off.
- Test pin for all-on (SEG\_TEST) and all-off (BLANK)
- Can be cascade-connected
- Can be synchronized with the external common signal
- Applicable as an output expander
- Package
  - 80-pin plastic TQFP (TQFP80-P-1212-0.50-K) (Product name: ML9472TB)

**BLOCK DIAGRAM**



**PIN CONFIGURATION (TOP VIEW)**



**80-Pin Plastic TQFP**

## PIN DESCRIPTION

Symbol	Type	Description
OSC_IN OSC_OUT $\overline{\text{OSC\_OUT}}$	I O O	Pins for oscillation. The oscillator circuit is configured by externally connecting two resistors and a capacitor. Make the wiring length as short as possible, because the resistor connected to the OSC_IN pin has a higher value and the circuit is susceptible to external noise.
DATA_IN	I	Serial data input pin. The display goes on when input data is at a "H" level, and it goes off when input data is at a "L" level.
CLOCK	I	Shift clock input pin. Data from the DATA pin is transferred in synchronization with the rising edge of the shift clock.
LOAD	I	Load signal input pin. Serially input data is transferred to the 60-bit latch at a "H" level of this load signal, then held at a "L" level.
$\overline{\text{BLANK}}$	I	Input pin that turns off all segments. The entire display goes off when a "L" level is applied to this pin. The display returns to the previous state when a "H" level is applied. When SEG_TEST pin is at a "H" level, the input on this pin is disabled.
SEG_TEST	I	Input pin is used to test the segment outputs (SEG <sub>1</sub> to SEG <sub>60</sub> ). All displays are turned on when "H" is applied to this pin. The display returns to the previous state when a "L" level is applied. When this pin is at a "H" level, the input on the $\overline{\text{BLANK}}$ pin is disabled.
D/S	I	When "H" is applied to this pin, the ML9472 operates in the 1/2 duty dynamic display mode. When this pin is set at a "L" level, the ML9472 operates in the static display mode.
EXT/INT	I	When the external common signal is used, fix this pin at a "H" level and input the external common signal from the OSC_IN pin. The input common signal is used as the internal common signal and is output from the COM_OUT pin through the buffer. When the built-in common signal generator is used, fix this pin at a "L" level. When the ML9472 is used as an output expander, fix this pin at a "H" level and the OSC_IN pin at a "L" level. The output logic can be reversed with respect to the input data by setting OSC_IN to a "H" level.
$\overline{\text{SYNC}}$	I/O	This pin is an input/output pin which is used when two or more ML9472s are connected in series (cascade connection) in the 1/2 duty dynamic display mode. All of the involved ML9472's $\overline{\text{SYNC}}$ pins should be connected by the common line and they should be pulled up with a common resistor, which makes a phase level of all involved ML9472's COM_A and COM_B pins equal. When a single ML9472 is used in the dynamic display mode, $\overline{\text{SYNC}}$ should be pulled up with a resistor. Connect this pin to GND if any of the following conditions is true: - The ML9472 is operated in the static display mode. - The ML9472 is used as an output expander.
DATA_OUT1	O	The 60 <sup>th</sup> stage data of the shift register is output from this pin. When two or more ML9472s are connected in series (cascade connection) in the static display mode, this pin should be connected to the next ML9472's DATA_IN Pin.
DATA_OUT2	O	The 120 <sup>th</sup> stage data of the shift register is output from this pin. When two or more ML9472s are connected in series (cascade connection) in the 1/2 duty dynamic display mode, this pin should be connected to the next ML9472's DATA_IN pin.
COM_OUT	O	When two or more ML9472s are connected in series (cascade connection), this pin should be connected with all of the slave ML9472's OSC_IN pins.

Symbol T	ype	Description
COM_A COM_B	O O	<p>LCD driving common signals is output from these pins. These pins should be connected to the COMMON side of the LCD panel.</p> <ul style="list-style-type: none"> <li>- In the static display mode A pulse in phase with the COM_OUT is output from both COM_A and COM_B. In this case, the high level is <math>V_{DD}</math>, and the low level is <math>V_{LC2}</math>.</li> <li>- In the 1/2 duty dynamic display mode The COM_A and COM_B output signals are alternately changed within each COM_OUT output cycle, resulting in alternate repetition of select and non-select modes.</li> </ul>
SEG1 to SEG60	O	Display output pins for LCD. These pins are connected to the SEGMENT side of the LCD panel. For the correspondence between the output of these pins and input data, see Section, "Data Structure".
$V_{LC1}, V_{LC2}$ —		<p>Bias pins for LCD driver. Through these pins, bias voltages for the LCD are externally supplied.</p> <p>In the static display mode, <math>V_{LC1}</math> should be open.</p> <p><math>V_{LC1} = V_{DD} / 2</math>  <math>V_{DD} &gt; V_{LC1} &gt; V_{LC2} = GND</math></p>
$V_{DD}, GND$	—	Supply voltage pin and ground pin.

Note: Built-in schmitt circuit is used for all input pins.

## ABSOLUTE MAXIMUM RATINGS

Parameter Sy	mbol	Condition	Rating	Unit
Supply Voltage	$V_{DD}$	$T_a = 25^\circ\text{C}$	-0.3 to 6.5	V
Input Voltage	$V_I$	$T_a = 25^\circ\text{C}$	-0.3 to $V_{DD}+0.3$	V
Storage Temperature	$T_{STG}$ —		-55 to 150	$^\circ\text{C}$
Power Dissipation	$P_D$ $T_a$	$< 105^\circ\text{C}$	<b>650</b>	mW
Output Current	$I_{O1}$ D	river Outputs	-2.0 to 2.0	mA
	$I_{O2}$ Logi	c Outputs	-2.0 to 2.0	mA

## RECOMMENDED OPERATING CONDITIONS

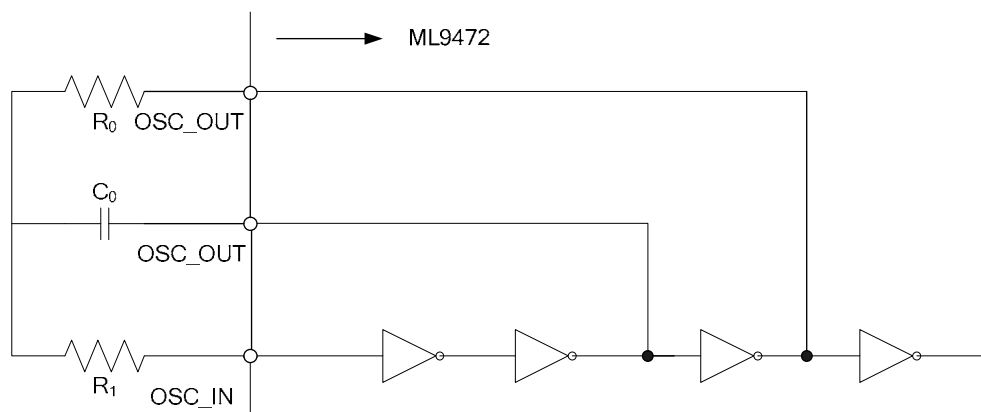
Parameter Sy	mbol	Condition	Range	Unit
Supply Voltage	$V_{DD}$	—	3 to 5.5	V
LCD Driving Voltage	$V_{LCD}$	$V_{DD} - V_{LC2}$	3 to $V_{DD}$	V
CLOCK Frequency	$f_{CP}$ —		0.3 to 4	MHz
Operating Temperature	$T_a$ —		-40 to 105	$^\circ\text{C}$

## OSCILLATOR CIRCUIT

Parameter Sy	mbol	Applicable pin	Condition	Min.	Typ.	Max.	Unit
Oscillator Resistance	$R_0$	$\overline{\text{OSC\_OUT}}$	— 56		100	220	$\text{k}\Omega$
Oscillator Capacitance	$C_0$	OSC_— OUT	Film capacitor	0.001	— 0.047		$\mu\text{F}$
Current Limiting Resistance	$R_1$	OSC_— IN	$R_1 \geq 10R_0$ 560		1000	2220	$\text{k}\Omega$
Common Signal Frequency	$f_{COM}$	COM_A COM_B	— 25		—	150	Hz

Note: See Section, “Reference Data”, for the resistor and capacitor values in the table.

Example of an oscillator circuit:



## ELECTRICAL CHARACTERISTICS

## DC Characteristics

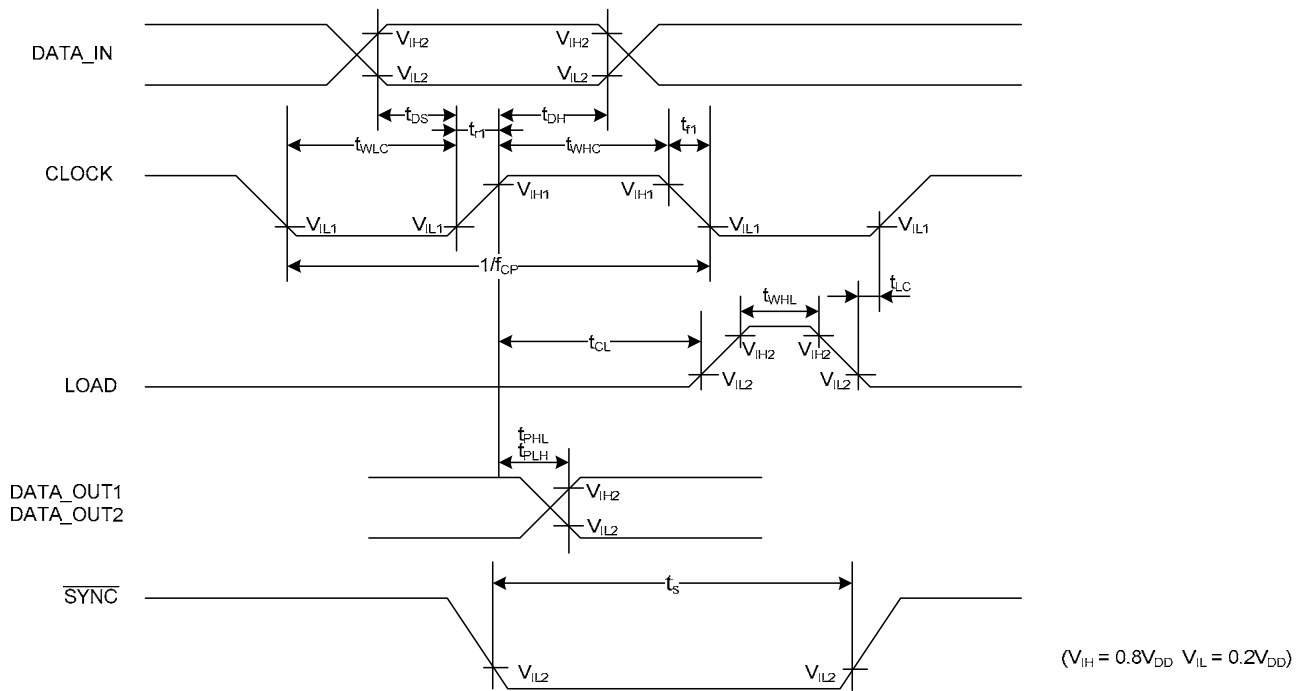
(V<sub>DD</sub> = 3.0 to 5.5 V, T<sub>a</sub> = -40 to +105°C, unless otherwise specified)

Parameter S	Symbol	Applicable pin	Condition	Min.	Max.	Unit	
"H" Input Voltage	V <sub>IH</sub>	SEG_TEST, BLANK, LOAD,		0.8 V <sub>DD</sub>	V <sub>DD</sub>	V	
"L" Input Voltage	V <sub>IL</sub>	DATA_IN,		GND	0.2 V <sub>DD</sub>	V	
"H" Input Current	I <sub>IH</sub>	CLOCK, D/S, EXT/INT,	V <sub>I</sub> = V <sub>DD</sub>	—	1	μA	
"L" Input Current	I <sub>IL</sub>	OSC_IN	V <sub>I</sub> = 0 V	-1	—	μA	
"H" Output Voltage	V <sub>OH1</sub>	DATA_OUT1 DATA_OUT2 COM_OUT	I <sub>O</sub> = -100 μA, V <sub>DD</sub> = 5.0 V	4.5	—	V	
	V <sub>OH2</sub>	OSC_OUT OSC_OUT	I <sub>O</sub> = -200 μA, V <sub>DD</sub> = 5.0 V	4.5	—	V	
"L" Output Voltage	V <sub>OL1</sub>	DATA_OUT1 DATA_OUT2 COM_OUT	I <sub>O</sub> = 100 μA, V <sub>DD</sub> = 5.0 V	—	0.5	V	
	V <sub>OL2</sub>	OSC_OUT OSC_OUT	I <sub>O</sub> = 200 μA, V <sub>DD</sub> = 5.0V	—	0.5	V	
	V <sub>OL3</sub>	SYNC	I <sub>O</sub> = 250 μA, V <sub>DD</sub> = 5.0 V	—	0.8	V	
COMMON Output Voltage	V <sub>OCH</sub>	COM_A COM_B	V <sub>DD</sub> = 5.0 V, V <sub>LC1</sub> = 2.5 V, V <sub>LC2</sub> = 0 V, I <sub>O</sub> = -150 μA	4.8	—	V	
	V <sub>OCM</sub>	COM_A COM_B	V <sub>DD</sub> = 5.0 V, V <sub>LC1</sub> = 2.5 V, V <sub>LC2</sub> = 0 V, I <sub>O</sub> = ±150 μA	2.3	2.7	V	
	V <sub>OCL</sub>	COM_A COM_B	V <sub>DD</sub> = 5.0 V, V <sub>LC1</sub> = 2.5 V, V <sub>LC2</sub> = 0 V, I <sub>O</sub> = 150 μA	—	0.2	V	
Segment O utput Voltage	V <sub>OSH</sub>	SEG <sub>1</sub> - SEG <sub>60</sub>	V <sub>DD</sub> = 5.0 V, V <sub>LC1</sub> = 2.5 V V <sub>LC2</sub> = 0 V	I <sub>O</sub> = -30 μA	4.8	—	V
	V <sub>OSL</sub>		I <sub>O</sub> = +30 μA	—	0.2	V	
Output Lea kage Current	I <sub>LO</sub>	SYNC	V <sub>DD</sub> = 5.0 V and V <sub>O</sub> = 5 V w hen internal Tr is off	—	5	μA	
Segment O utput Impedance	R <sub>SEG</sub>	SEG <sub>1</sub> - SEG <sub>60</sub>	V <sub>DD</sub> = 5.0 V, V <sub>LC1</sub> = 2.5V, V <sub>LC2</sub> = 0V	—	10	kΩ	
Common O utput Impedance	R <sub>COM</sub>	COM_A COM_B	V <sub>DD</sub> = 5.0 V, V <sub>LC1</sub> = 2.5V, V <sub>LC2</sub> = 0V	—	1.5	kΩ	
Static Sup ply Current	I <sub>DD1</sub>	V <sub>DD</sub>	Fix all in put levels at ei ther V <sub>DD</sub> or GND	—	100	μA	
Dynamic Sup ply Current	I <sub>DD2</sub>	V <sub>DD</sub>	V <sub>DD</sub> = 5.0V, No load. R <sub>0</sub> = 100 kΩ, C <sub>0</sub> = 0.01 μF, R <sub>1</sub> = 1 MΩ	—	0.5	mA	

AC Characteristics

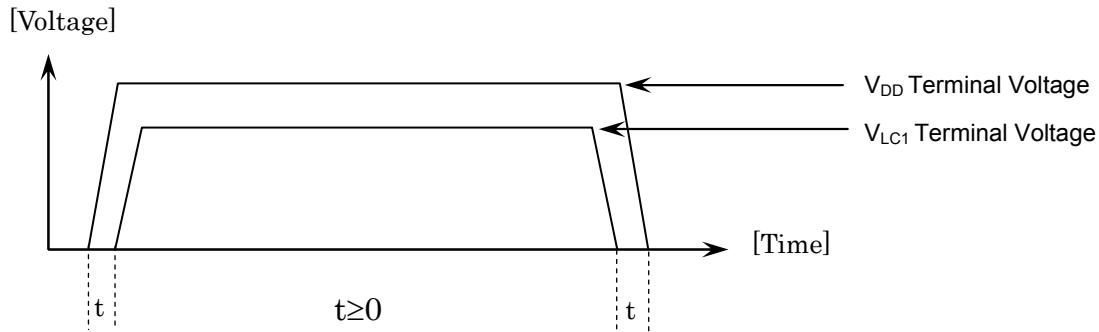
( $V_{DD} = 3$  to  $5.5$  V,  $T_a = -40$  to  $+105^\circ\text{C}$ , unless otherwise specified)

Parameter Sy	mbol	Condition M	in.	Typ.	Max.	Unit
Clock "H" Time	$t_{WHC}$		70	—	—	ns
Clock "L" Time	$t_{WLC}$		70	—	—	ns
Data Set-up Time	$t_{DS}$		50	—	—	ns
Data Hold Time	$t_{DH}$		50	—	—	ns
Load "H" Time	$t_{WHL}$		100	—	—	ns
Clock-to-load Time	$t_{CL}$		100	—	—	ns
Load-to-Clock Time	$t_{LC}$		100	—	—	ns
"H", "L" Propagation Delay Time	$t_{PHL}$ $t_{PLH}$	Load capacitance of DATA_OUT1, DATA_OUT2: 15 pF	—	—	0.14	$\mu\text{s}$
Clock Rise time, Fall time	$t_{r1}$ , $t_{f1}$		—	—	50	ns
SYNC Pulse "L" Time	$t_s$		0.2	—	—	$\mu\text{s}$
OSC_IN Input Frequency	$f_{OSC}$		—	—	5	kHz



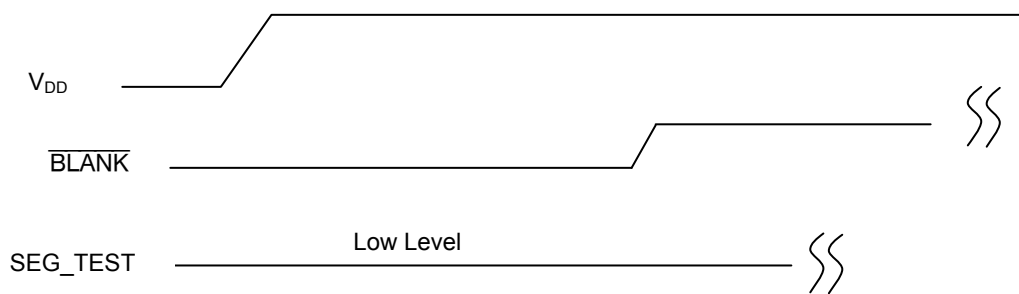


**POWER-ON/OFF TIMING**



\* Please start up  $V_{LC1}$  after turning on the  $V_{DD}$  power supply. Or, please start up at the same time.

**INITIAL SIGNAL TIMING**

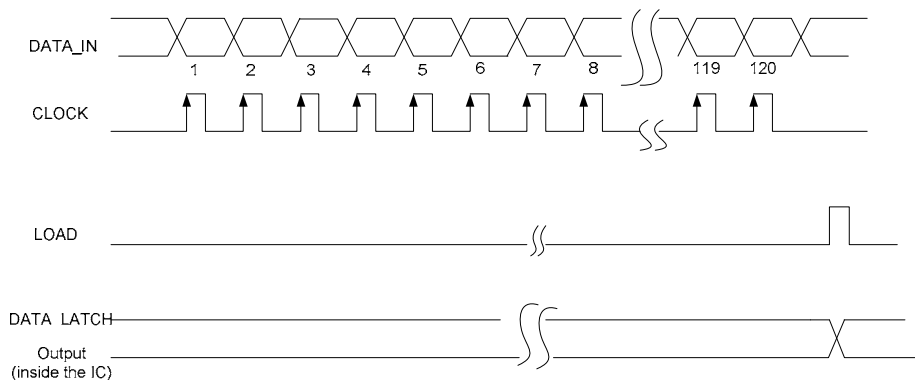


\* After  $V_{DD}$  is applied,  $\overline{BLANK}$  and  $SEG\_TEST$  should be applied to 'L' level to make all SEGMENTS off until first group of display data is latched.

**FUNCTIONAL DESCRIPTION**

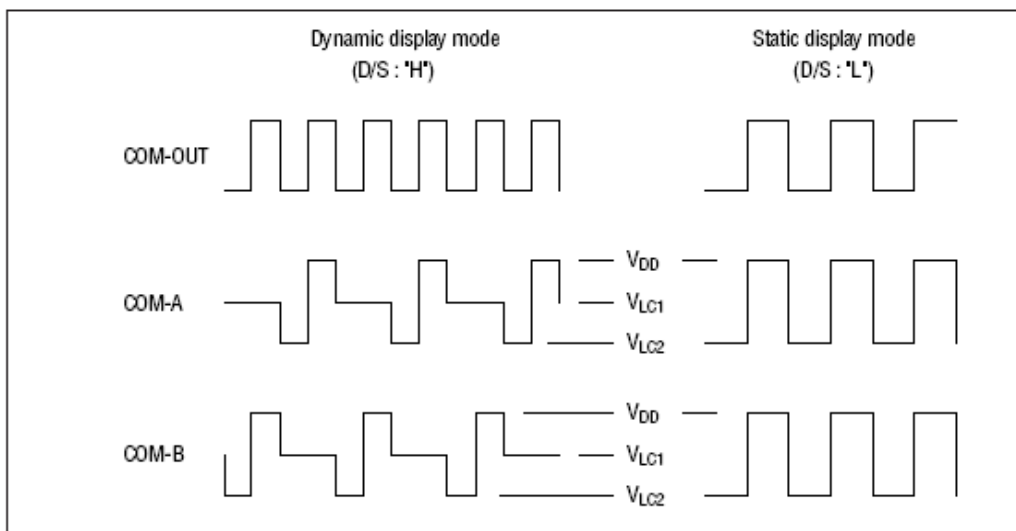
**Operation Description**

The ML9472 consists of a 120-stage shift register, 120-bit data latch, and 60 pairs of LCD drivers. The display data is input from the  $DATA\_IN$  pin to the 120-stage shift register at the rising edge of the  $CLOCK$  pulse and it is shifted to the 120-bit data latch when the  $LOAD$  signal is set at "H" level, then it is directly output from the 60 pairs of LCD drivers to the LCD panel. Input the display data in the order of  $SEG60, SEG59, SEG58, \dots, SEG2, SEG1$ .



### COM\_A, COM\_B

In the select mode, a signal in phase with the COM\_OUT signal is output at “H” ( $V_{DD}$ ) and “L” ( $V_{LC2}$ ).  
 In the non-select mode a voltage is output at “M” ( $V_{LC1}$ ). In the select mode of COM\_A (non-select mode of COM\_B), signals that correspond to the 1<sup>st</sup>-to 60<sup>th</sup>-bit data of the data latch are output to the segment outputs.  
 In the select mode of COM\_B (non-select mode of COM\_A), signals that correspond to the 61<sup>st</sup>- to 120<sup>th</sup>-bit data of the data latch are output to the segment outputs.



SEGN Truth Table

Mode	Display data in LatchA	Display data in LatchB	COMA CO	MB	SEGN
Static	1	— “H”		“H”	0
		— “L”		“L”	1
	0	— “H”		“H”	1
		— “L”		“L”	0
1/2 duty Dynamic	1 1		“H” “M	”	0
			“L” “M	”	1
			“M” “H”	”	0
			“M” “L”	”	1
	1 0		“H” “M	”	0
			“L” “M	”	1
			“M” “H”	”	1
			“M” “L”	”	0
	0 1		“H” “M	”	1
			“L” “M	”	0
			“M” “H”	”	0
			“M” “L”	”	1
	0 0		“H” “M	”	1
			“L” “M	”	0
			“M” “H”	”	1
			“M” “L”	”	0

\*Note: “H” =  $V_{DD}$ ; “M” =  $V_{LC1}$ ; “L” =  $V_{LC2}$ .

**SEG1-SEG60**

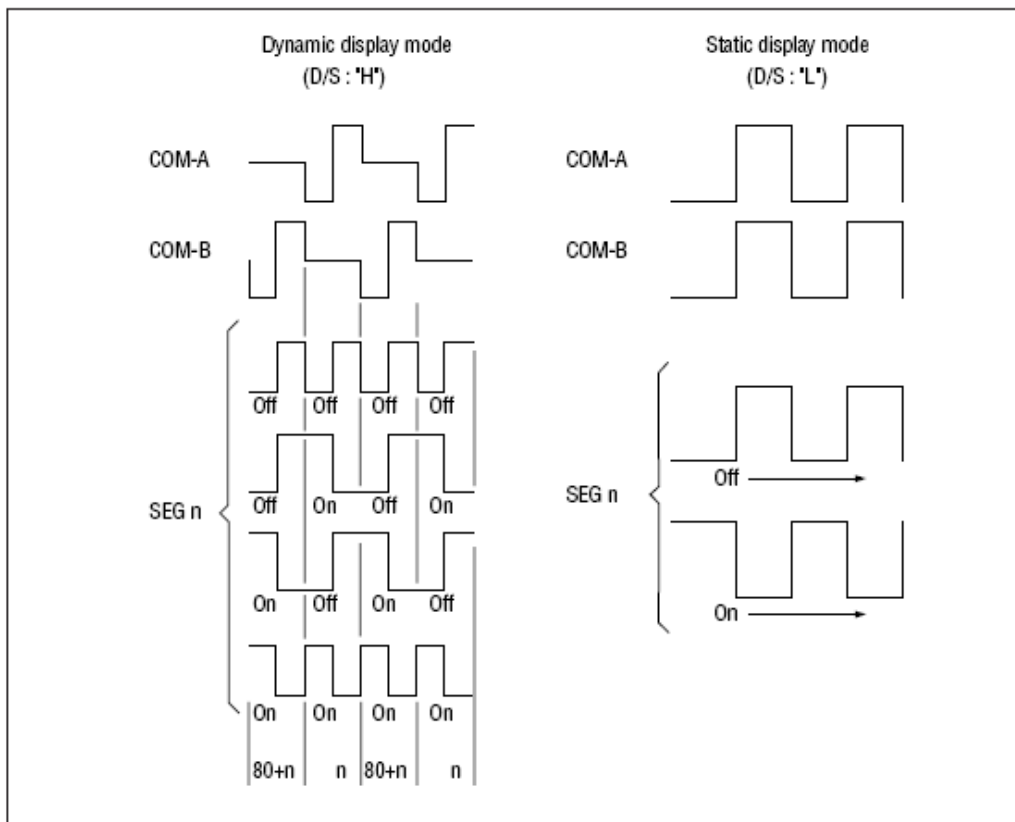
LCD segment driving signals are output from these pins and they should be connected to the segment side of the LCD panel.

“H” level:  $V_{DD}$ , “L” level:  $V_{LC2}$

In the static display mode, the nth bit data of the data latch (A) corresponds to the SEGn. The data of the data latch (B) is invalid.

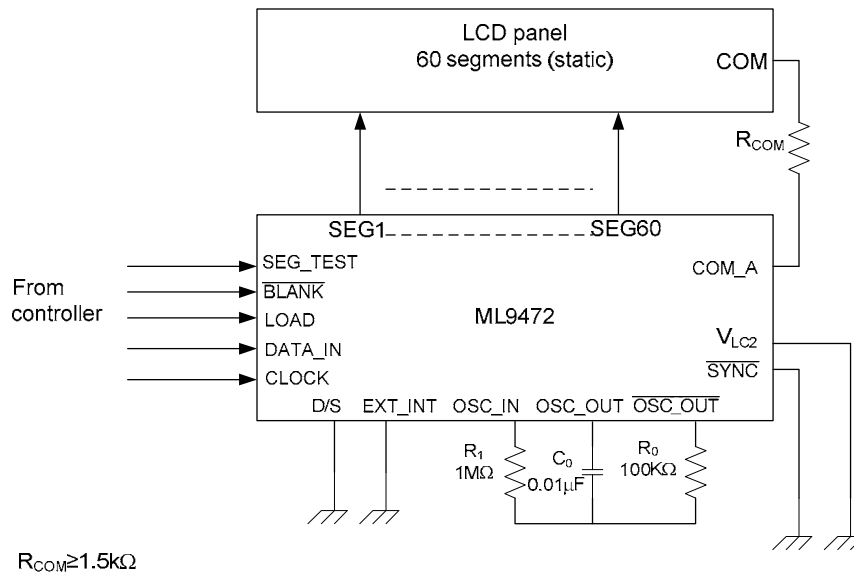
A signal out of phase with the COM\_OUT signal is output to the segment outputs when the display is turned on, while a signal in phase with it is output when the display is turned off.

In the 1/2 duty dynamic mode, the output of the SEGn corresponds to the nth bit data of the data latch (A) when COM\_A is in select mode and corresponds to the nth bit data of the data latch (B) when COM\_B is in select mode. When the display is turned on, a signal out of phase with the common signal corresponding to the data is output, while a signal in phase with the common signal is output when the display is turned off.

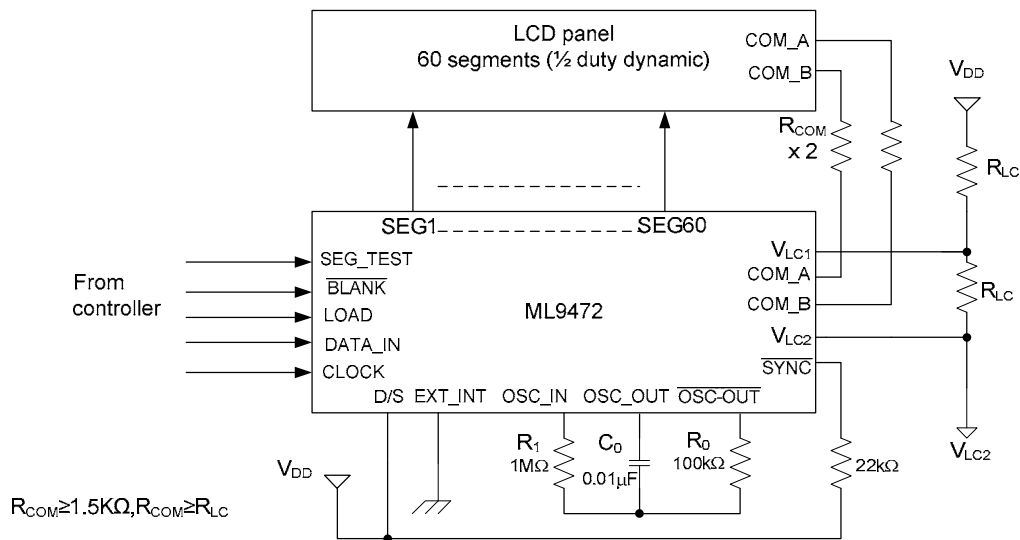


### APPLICATION CIRCUITS

#### 1) Single ML9472 operation in the static display mode

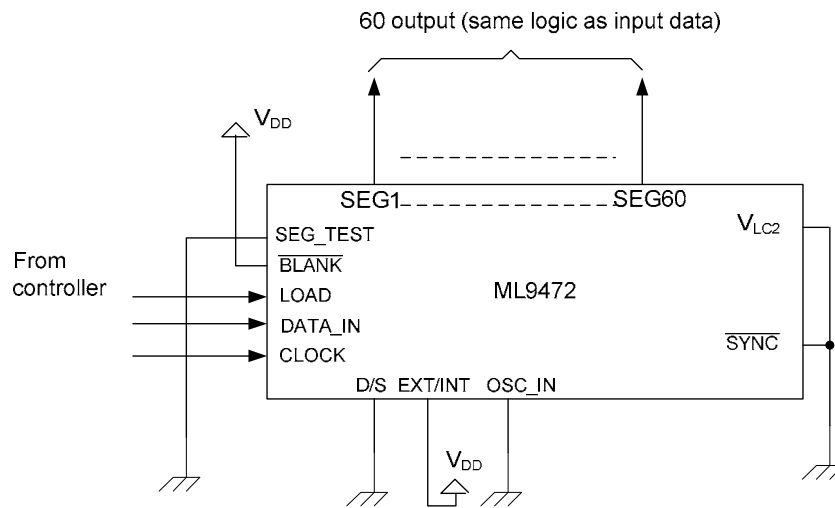


#### 2) Single ML9472 operation in the 1/2 duty dynamic display mode





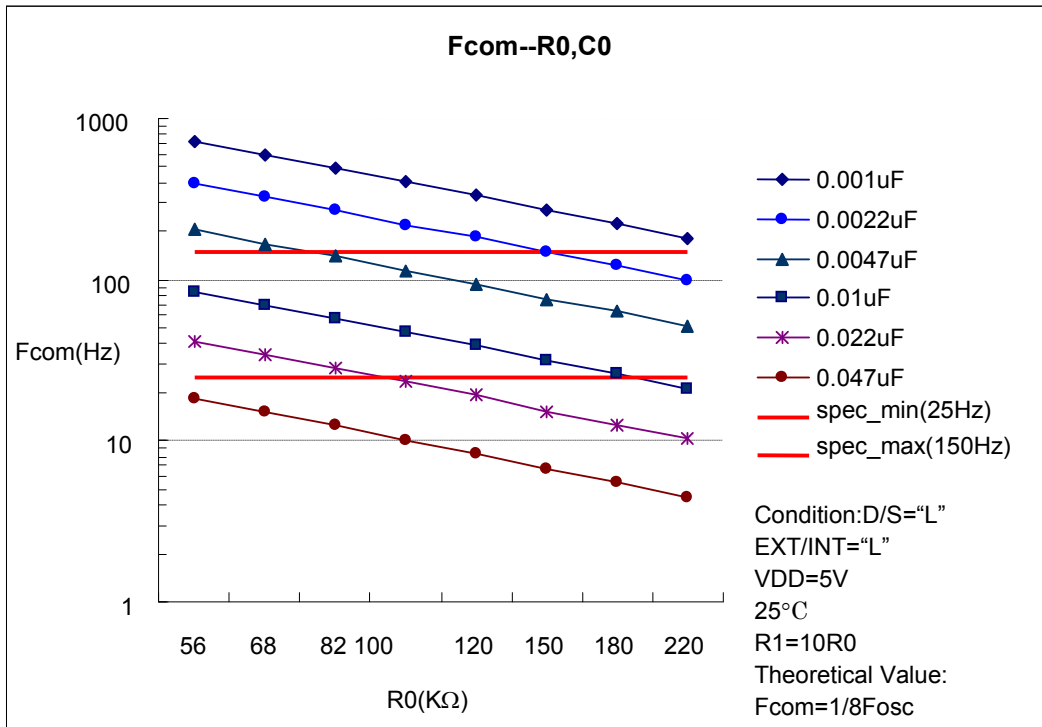
## 5) Output-expander



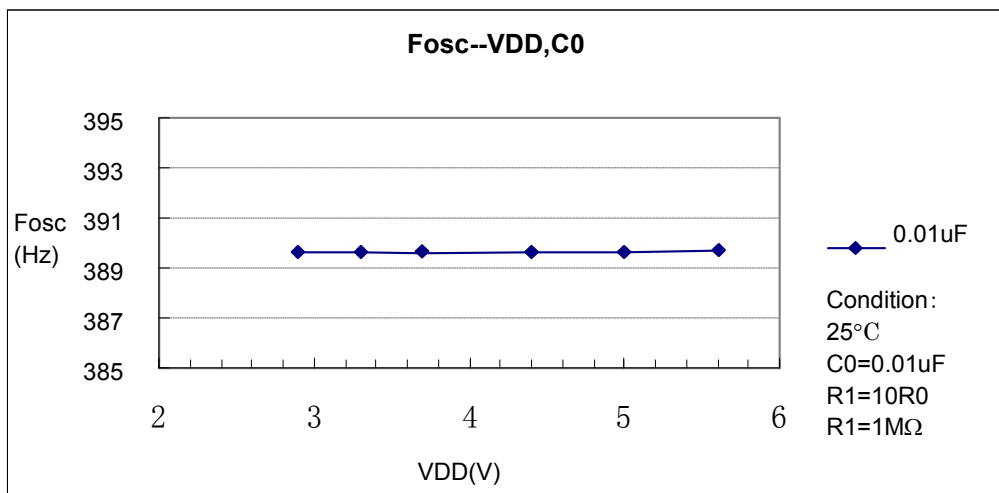
\*The output logic can be reversed with respect to the input data by setting OSC\_IN to "H" level.

**REFERENCE CHARACTERISTICS**

**Fcom — R0,C0**

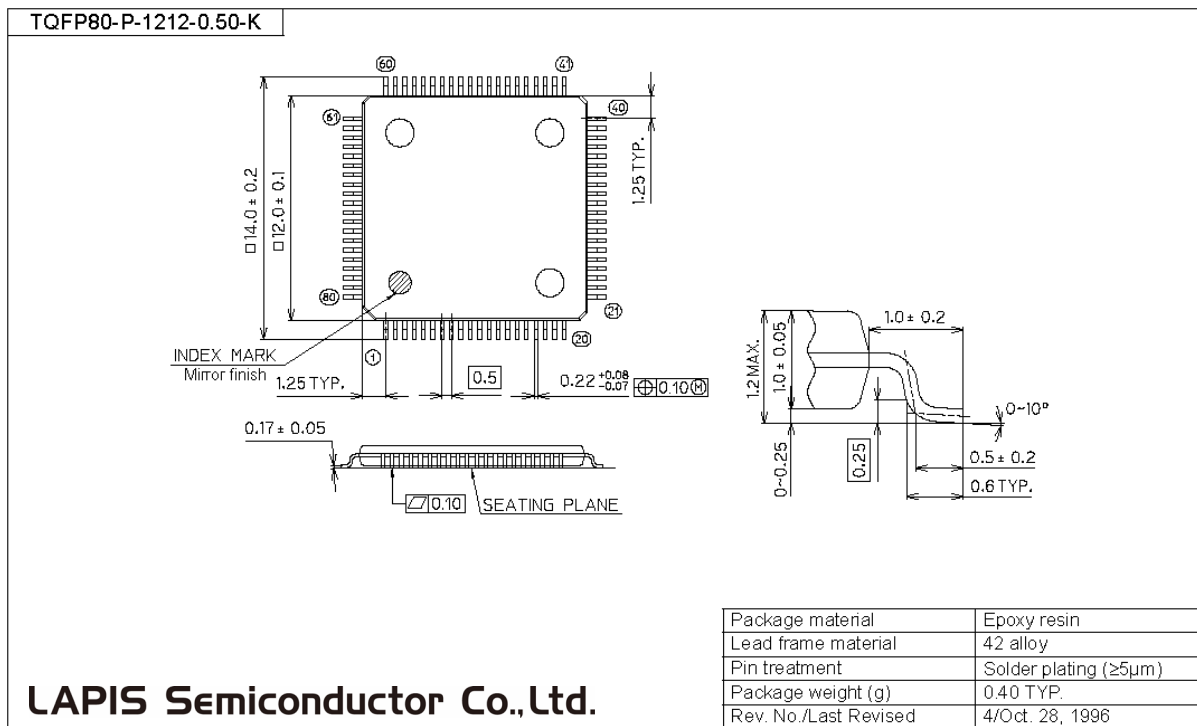


**Fosc — VDD,C0**



**PACKAGE DIMENSIONS**

(Unit: mm)



**Notes for Mounting the Surface Mount Type Package**

The surface mount type packages are very susceptible to heat in reflow mounting and humidity absorbed in storage. Therefore, before you perform reflow mounting, contact ROHM's responsible sales person for the product name, package name, pin number, package code and desired mounting conditions (reflow method, temperature and time).



**REVISION HISTORY**

Document No.	Date	Page		Description
		Previous Edition	Current Edition	
FEDL9472-01	July. 2, 2007	–	–	Final edition 1
FEDL9472-02 Feb.	1,2008	2	2	BLOCK DIAGRAM
		6	6	Power Dissipation 794mW→650mW
		7	7	Segment Output Impedance Condition Common Output Impedance Condition
		9	9	POWER-ON/OFF TIMING
		10	10	SEgN Truth Table
		14	14	Output-expander
		–	15	Reference Characteristics

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